Isolated USB Transceiver with Isolated Power

FEATURES

- **LTM2884: 2500V_{RMS} for 1 Minute**
- **LTM2884(a): 3000V_{RMS} for 1 Minute**
- **LTM2884: UL Recognized File #E151738**
- **LTM2884(a): CSA Recognized File #255632**
- **USB 2.0 Full Speed and Low Speed Compatible**
- **Integrated Isolated DC/DC Converter, External or Bus Powered**
- **Auto-Configuration of Bus Speed**
- 2.5W (500mA at 5V) Output Power from External Input Supply (V_{CC} = 8.6V to 16.5V)
- 1W (200mA at 5V) Output Power from USB Bus Supply (V_{BUS})
- 3.3V LDO Output Supply Signal References V_{LO}, V_{LO2}
- High Common Mode Transient Immunity: 30kV/µs
- ESD: ±15kV HBM on USB Interface Pins
- 15mm × 15mm × 5mm Surface Mount BGA Package

APPLICATIONS

- Isolated USB Interfaces
- Host, Hub, or Device Isolation
- Industrial/Medical Data Acquisition

All registered trademarks and trademarks are the property of their respective owners.

DESCRIPTION

The LTM®2884 is a complete galvanically isolated USB 2.0 compatible µModule® (micromodule) transceiver. An upstream supply powers both sides of the interface through an integrated, isolated DC/DC converter.

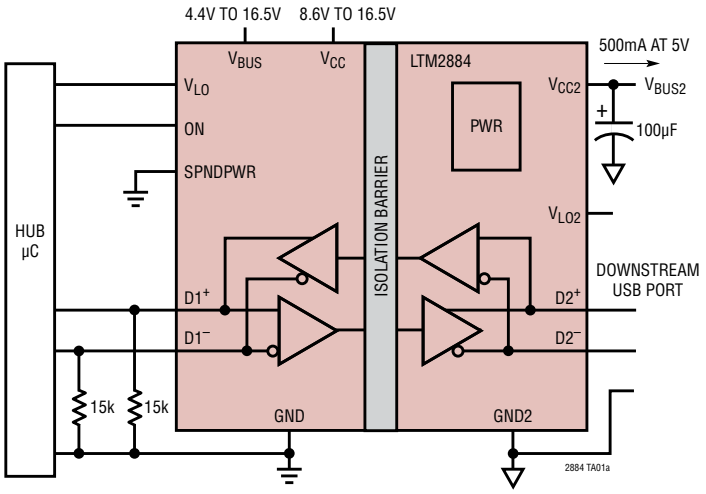
The LTM2884 is ideal for isolation in host, hub, bus splitter or peripheral device applications. It is compatible with USB 2.0 full speed (12Mbps) and low speed (1.5Mbps) operation. Automatic speed selection configures integrated pull-up resistors on the upstream port to match those sensed on the downstream device.

The isolator µModule technology uses coupled inductors and an isolated power transformer to provide isolation between the upstream and downstream USB interface. This device is ideal for systems requiring isolated ground returns or large common mode voltage variations. Uninterrupted communication is guaranteed for common mode transients greater than 30kV/µs.

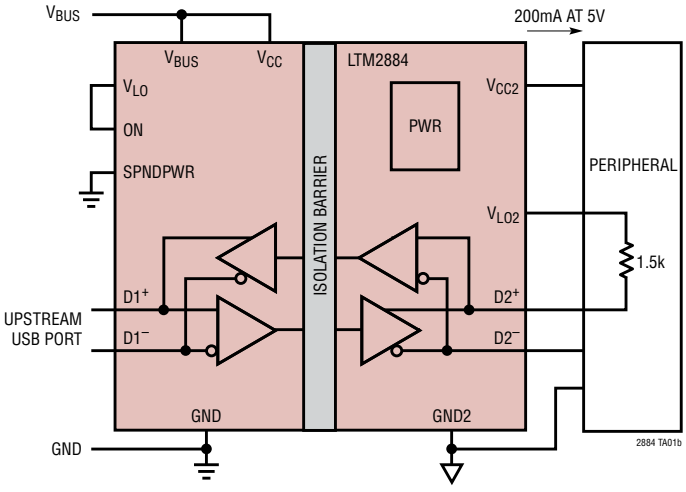
Enhanced ESD protection allows this part to withstand up to ±15kV (human body model) on the USB transceiver interface pins to local supplies and ±15kV through the isolation barrier to supplies without latch-up or damage.

TYPICAL APPLICATION

Powered 2.5W Isolated Hub Port



Bus Powered 1W Isolated Peripheral Device



ABSOLUTE MAXIMUM RATINGS

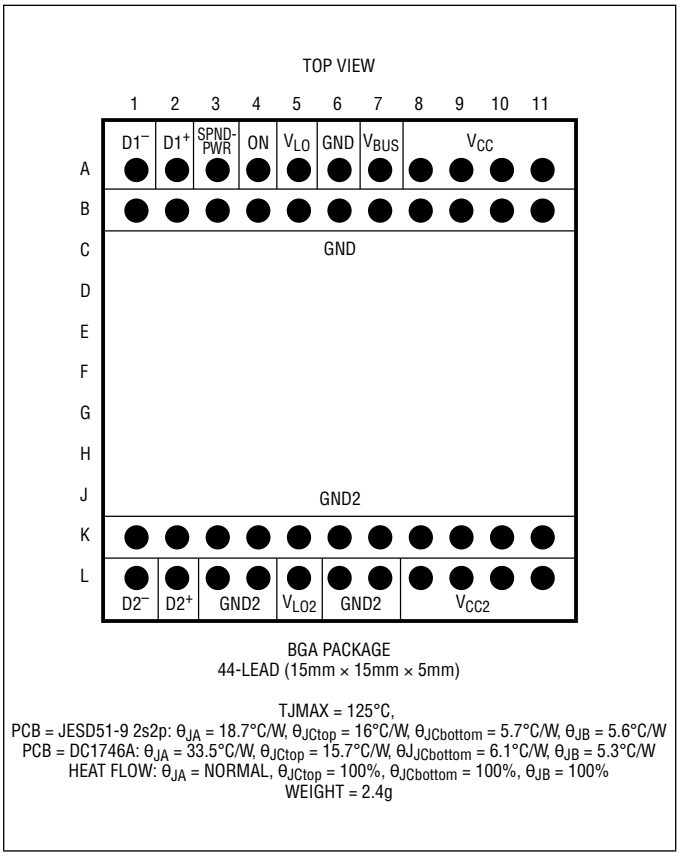
(Note 1)

Supply Voltages
- V_{CC} to GND ..... –0.3V to 18V
- V_{BUS} to GND ..... –0.3V to 18V
- V_{CC2} to GND2 ..... –0.3V to 10V

V_{LO} to GND ..... –0.3V to 4V
V_{LO2} to GND2 ..... –0.3V to 4V
ON, SPNDPWR to GND ..... –0.3V to (V_{LO} + 0.3V)
$D1^+$, $D1^-$ to GND ..... –0.3V to 5.3V
$D2^+$, $D2^-$ to GND2 ..... –0.3V to 5.3V
Operating Ambient Temperature Range (Note 3)
- LTM2884C ..... 0°C to 70°C
- LTM2884I ..... –40°C to 85°C
- LTM2884H ..... –40°C to 105°C

Storage Temperature Range ..... –55°C to 125°C
Maximum Internal Operating Temperature ..... 125°C
Peak Body Reflow Temperature ..... 245°C

PIN CONFIGURATION



BGA PACKAGE
44-LEAD (15mm × 15mm × 5mm)

TJMAX = 125°C,
PCB = JESD51-9 2s2p: θ_{JA} = 18.7°C/W, θ_{JCtop} = 16°C/W, $\theta_{JCbottom}$ = 5.7°C/W, θ_{JB} = 5.6°C/W
PCB = DC1746A: θ_{JA} = 33.5°C/W, θ_{JCtop} = 15.7°C/W, $\theta J_{Cbottom}$ = 6.1°C/W, θ_{JB} = 5.3°C/W
HEAT FLOW: θ_{JA} = NORMAL, θ_{JCtop} = 100%, $\theta_{JCbottom}$ = 100%, θ_{JB} = 100%
WEIGHT = 2.4g

ORDER INFORMATION

PART NUMBER	PAD OR BALL FINISH	PART MARKING		PACKAGE TYPE	MSL RATING	TEMPERATURE RANGE
		DEVICE	FINISH CODE			
LTM2884CY#PBF	SAC305 (RoHS)	LTM2884Y*	e1	BGA	4	0°C to 70°C
LTM2884IY#PBF						–40°C to 85°C
LTM2884HY#PBF						–40°C to 105°C

- Device temperature grade is indicated by a label on the shipping container.
- Pad or ball finish code is per IPC/JEDEC J-STD-609.
- Recommended BGA PCB Assembly and Manufacturing Procedures.
- BGA Package and Tray Drawings

* A lower case “a” appearing next to the package pin 1 identifier indicates a revised version of the LTM2884. All specifications and typical performance curves are applicable to both versions of the LTM2884 unless otherwise noted by LTM2884 or LTM2884(a).

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{CC} = 5V, V_{BUS} = 5V, GND = GND2 = 0V, ON = V_{LO}, unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Power Supply							
V_{CC}	Operating Supply Range (Isolated Power Input)		●	4.4	12	16.5	V
V_{BUS}	Operating Supply Range (USB Bus Power Input)		●	4.4	5	16.5	V
	V_{CC} Supply Current Power Off	ON = 0V, V_{CC} = 4.4V to 16.5V	●		100	500	µA
I_{CC}	V_{CC} Supply Current Power On	I_{CC2} = 0mA, Figure 1, LTM2884	●		50	100	mA
		I_{CC2} = 0mA, Figure 1, LTM2884(a)	●		9	35	mA
	V_{BUS} Supply Current Power Off	ON = 0V	●		10	100	µA
I_{BUS}	V_{BUS} Supply Current Power On	I_{VLO} = 0mA, Figure 1	●		6	9	mA
	V_{BUS} Supply Current Suspend Mode	SPNDPWR = 3.3V USB Suspend Timeout SPNDPWR = 0, USB Suspend Timeout	● ●			500 2.0	µA mA
V_{CC2}	Regulated V_{CC2} Output Voltage, Loaded LTM2884	V_{CC} = 4.4V, I_{CC2} = 200mA, Figure 1 V_{CC} = 8.6V, I_{CC2} = 500mA, Figure 1	● ●	4.75 4.75	5 5	5.25 5.25	V V
	Regulated V_{CC2} Output Voltage, Loaded LTM2884(a)	V_{CC} = 4.4V, I_{CC2} = 200mA, Figure 1 V_{CC} = 8.6V, I_{CC2} = 500mA, Figure 1		4.75 4.75	5 5	5.25 5.25	V V
		V_{CC} = 4.4V, I_{CC2} = 200mA, Figure 1 V_{CC} = 8.6V, I_{CC2} = 500mA, Figure 1	● ●	4.5 4.5	5 5	5.5 5.5	V V
	V_{CC2} Source Current High Power Mode	V_{CC} = 8.6V, Figure 1	●	500			mA
	V_{CC2} Source Current Bus Power Mode	V_{CC} = V_{BUS} = 4.4V, Figure 1	●	200			mA
V_{LO}	V_{LO} Regulated Output Voltage	I_{VLO} = 0mA to 10mA,Figure 1	●	3.15	3.3	3.45	V
	V_{LO} Output Voltage Maximum Current	Figure 1	●			10	mA
V_{LO2}	V_{LO2} Regulated Output Voltage	I_{VLO2} = 0mA to 10mA, Figure 1	●	3.15	3.3	3.45	V
	V_{LO2} Output Voltage Maximum Current	Figure 1	●			10	mA
USB Input Levels ($D1^+$, $D1^-$, $D2^+$, $D2^-$)							
V_{IH}	Single-Ended Input High Voltage		●	2.0			V
V_{IL}	Single-Ended Input Low Voltage		●			0.8	V
V_{HYS}	Single-Ended Input Hysteresis				200		mV
V_{DIFF}	Differential Input Sensitivity	$\lvert(D1^+ - D1^-)\rvert$ or $\lvert(D2^+ - D2^-)\rvert$	●	0.2			V
V_{CM}	Common Mode Voltage Range	$\lvert(D1^+ + D1^-)\rvert/2$ or $\lvert(D2^+ + D2^-)\rvert/2$	●	0.8		2.5	V
Logic Input Levels (ON, SPNDPWR)							
V_{IHL}	Logic Input High Voltage		●	2.0			V
V_{ILL}	Logic Input Low Voltage		●			0.8	V
I_{INL}	Logic Input Current		●			±1	µA
V_{HYSL}	Logic Input Hysteresis				200		mV
USB Output Levels ($D1^+$, $D1^-$, $D2^+$, $D2^-$)							
V_{OL}	Output Low Voltage	R_{PU} = 1.5k to 3.6V, Figure 4	●	0		0.3	V
V_{OH}	Output High Voltage	R_{PD} = 15k to 0V, Figure 4	●	2.8		3.6	V
V_{CRS}	Differential Output Signal Cross-Point Voltage		●	1.3		2.0	V
Terminations							
R_{PU}	Bus Pull-Up Resistance on Upstream Facing Port	$D2^+$ or $D2^-$ Pull-Up to 3.3V		1.425		1.575	kΩ
R_{PD}	Bus Pull-Down Resistance on Downstream Facing Port	$D2^+$ and $D2^-$ Pull-Down to GND2		14.25		15.75	kΩ
Z_{DRV}	USB Driver Output Resistance		●	28		44	Ω
C_{INUSB}	USB Transceiver Pad Capacitance to GND	(Note 2)			10		pF

SWITCHING CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{CC} = 5V, V_{BUS} = 5V, GND = GND2 = 0V, ON = V_{LO}, unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Low Speed USB							
t_{LDR}	Low Speed Data Rate	C_L = 50pF to 450pF (Note 4)			1.5		Mbps
t_{LR}	Rise Time	Figure 2, C_L = 50pF to 600pF	●	75		300	ns
t_{LF}	Fall Time	Figure 2, C_L = 50pF to 600pF	●	75		300	ns
t_{LPRR}, t_{LPFF}	Propagation Delay	Figure 2, C_L = 50pF to 600pF	●		200	300	ns
t_{LDJ1}	Differential Jitter	To Next Transition (Note 2)				±45	ns
t_{LDJ2}	Differential Jitter	To Paired Transitions (Note 2)				± 15	ns
Full Speed USB							
t_{FDR}	Full Speed Data Rate	C_L = 50pF (Note 4)			12		Mbps
t_{FR}	Rise Time	Figure 3, C_L = 50pF	●	4		20	ns
t_{FF}	Fall Time	Figure 3, C_L = 50pF	●	4		20	ns
t_{FPRR}, t_{FPFF}	Propagation Delay	Figure 3, C_L = 50pF	●	60	80	115	ns
t_{FDJ1}	Differential Jitter	To Next Transition (Note 2)			2		ns
t_{FDJ2}	Differential Jitter	To Paired Transitions (Note 2)			1		ns
Power Supply Generator							
	V_{CC2} – GND2 Supply Start-Up Time (ON ↑ V_{LO}, V_{CC2} to 4.5V)	R_{LOAD} = 50Ω, C_{LOAD} = 100µF R_{LOAD} = 10Ω, C_{LOAD} = 100µF, V_{CC} = 12V	● ●		2 3	5 10	ms ms
t_{WUSPND}	Wake Up from Suspend Mode	Resume Signal, SPNDPWR = 0	●		0.25	10	µs
ESD (HBM) (Note 2)	Isolation Barrier	GND to GND2			±15		kV
	$D1^+$, $D1^-$, $D2^+$, $D2^-$	$D1^+/D1^-$ to GND, V_{CC}, V_{BUS}, or V_{LO} and $D2^+/D2^-$ to GND2, V_{CC2}, or V_{LO2}			±15		kV
	ON, SPNDPWR				±3		kV

ISOLATION CHARACTERISTICS

T_A = 25°C.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Isolation Barrier: GND to GND2						
V_{ISO}	Rated Dielectric Insulation Voltage (Notes 6, 7)	1 Minute (Derived from 1 Second Test) LTM2884 LTM2884(a)	 2500 3000			 V_{RMS} V_{RMS}
		1 Second (Note 5) LTM2884 LTM2884(a)	 3000 3600			 V_{RMS} V_{RMS}
	Common Mode Transient Immunity	V_{BUS} = V_{CC} = 5V, ON = 3.3V, 1000V in 33ns Transient Between GND and GND2 (Note 2)	±30			kV/µs
V_{IORM}	Maximum Working Insulation Voltage	(Notes 2, 5)	560 400			V_{PEAK} V_{RMS}
	Partial Discharge	V_{PR} = 750V_{RMS} (Note 5)			<5	pC
CTI	Comparative Tracking Index	IEC 60112 (Note 2)	600			V_{RMS}
	Depth of Erosion	IEC 60112 (Note 2)		0.017		mm
DTI	Distance Through Insulation	(Note 2)		0.1		mm
	Input to Output Resistance	(Notes 2, 5)	10^{12}			Ω
	Input to Output Capacitance	(Notes 2, 5)		13		pF
	Creepage Distance	(Notes 2, 5)		9.48		mm

REGULATORY INFORMATION

CSA (Note 8)
CSA 60950-1-07+A1+A2 and IEC 60950-1, Second Edition, +A1 +A2:
Basic Insulation at $930V_{RMS}$
Reinforced Insulation at $415V_{RMS}$
CSA 62368-1-14 and IEC 62368-1-14:2014, Second Edition:
Basic Insulation at $600V_{RMS}$
Reinforced Insulation at $300V_{RMS}$
CSA 60601-1:14 and IEC 60601-1, Third Edition, +A1:
Two Means of Patient Protection (2 MOPP) at $150V_{RMS}$
UL 1577-2015:
Single Protection, $3000V_{RMS}$ Isolation Voltage
File 255632

ELECTRICAL CHARACTERISTICS

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: Guaranteed by design and not production tested.

Note 3: This µModule transceiver includes over temperature protection that is intended to protect the device during momentary overload conditions. Junction temperature will exceed 125°C when over temperature protection is active. Continuous operation above specified maximum operating junction temperature may result in device degradation or failure.

Note 4: Maximum data rate is guaranteed by other measured parameters and is not directly tested.

Note 5: Device considered a 2-terminal device. Measurement between groups of pins A1 through B11 shorted together and pins K1 through L11 shorted together.

Note 6: The rated dielectric insulation voltage should not be interpreted as a continuous voltage rating.

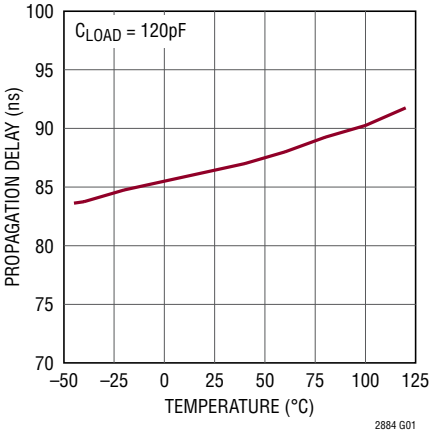
Note 7: In accordance with UL1577, each device is proof tested for the dielectric insulation voltage by applying the rated voltage multiplied by an acceleration factor of 1.2 for one second.

Note 8: Ratings are for pollution degree 2, material group 3 and overvoltage category II where applicable. Ratings for other environmental and electrical conditions to be determined from the appropriate safety standard.

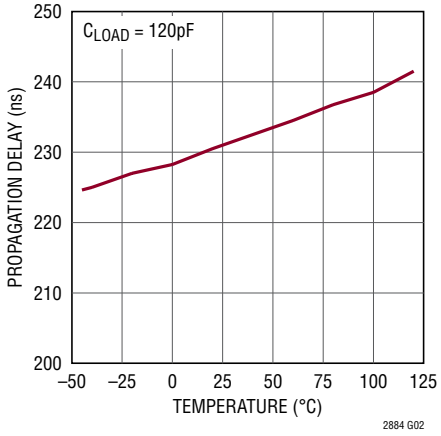
TYPICAL PERFORMANCE CHARACTERISTICS

T_A = 25°C, V_{CC} = 5V, V_{BUS} = 5V, GND = GND2 = 0V, ON = 3.3V, unless otherwise noted.

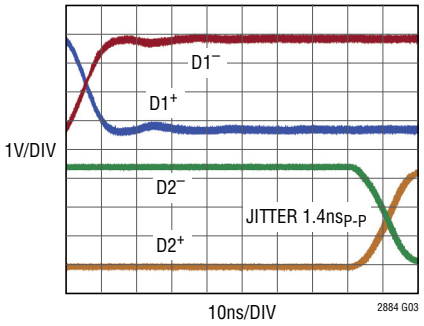
Full Speed Propagation Delay vs Temperature



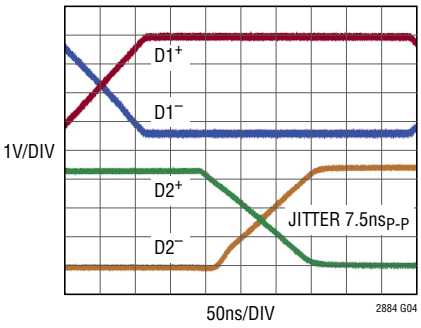
Low Speed Propagation Delay vs Temperature



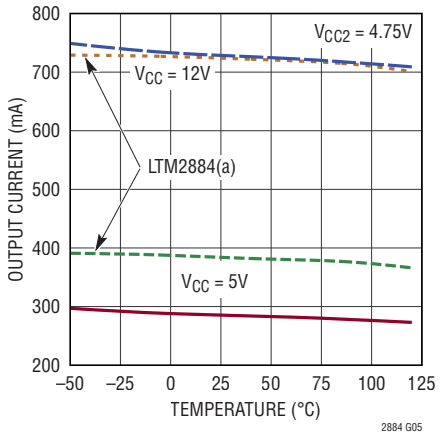
Full Speed Differential Jitter



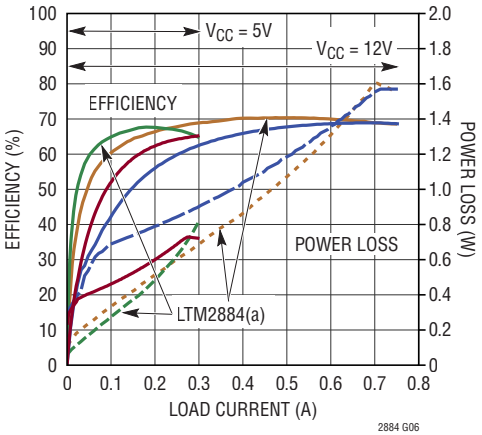
Low Speed Differential Jitter



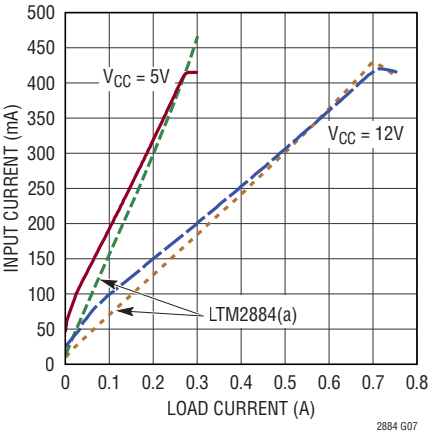
V_{CC2} Output Current vs Temperature



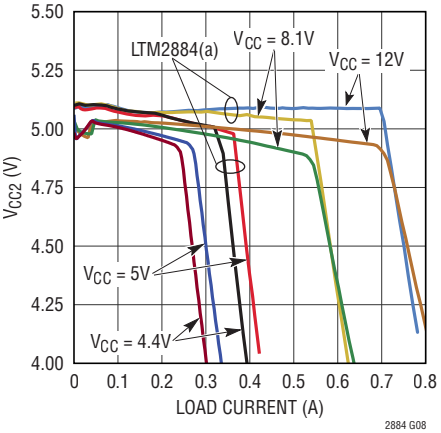
V_{CC} to V_{CC2} Efficiency and Power Loss



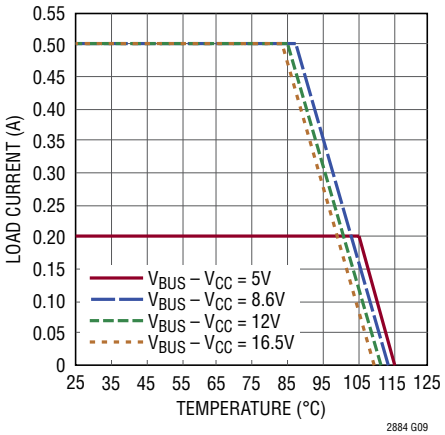
V_{CC} Input Current vs V_{CC2} Output Current



V_{CC2} Output Voltage vs Load Current



Derating for 125°C Maximum Internal Operating Temperature

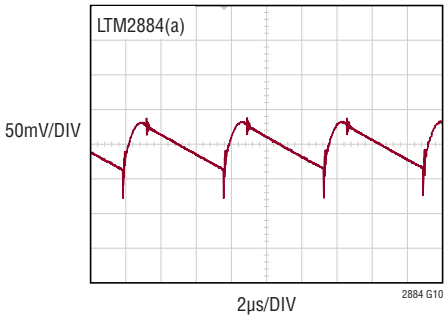


Rev. C

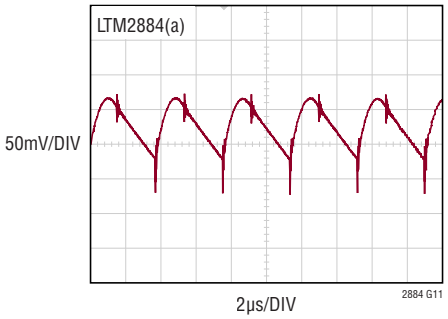
TYPICAL PERFORMANCE CHARACTERISTICS

T_A = 25°C, V_{CC} = 5V, V_{BUS} = 5V, GND = GND2 = 0V, ON = 3.3V, unless otherwise noted.

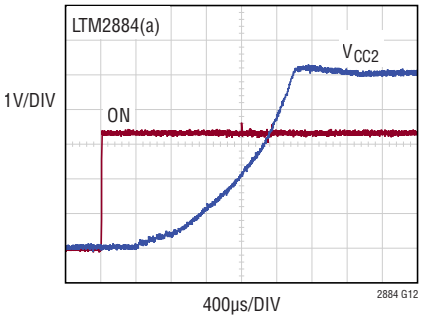
V_{CC2} Ripple, V_{CC} = 5V, I_{CC2} = 200mA



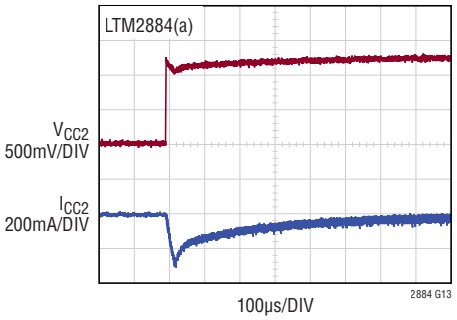
V_{CC2} Ripple, V_{CC} = 12V, I_{CC2} = 500mA



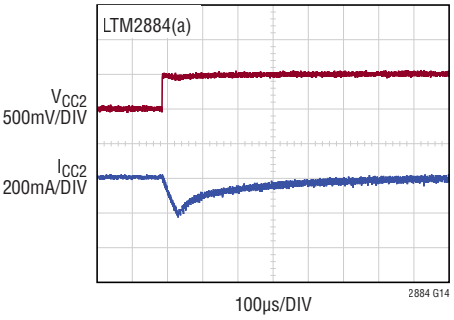
V_{CC2} Start-Up Ramp



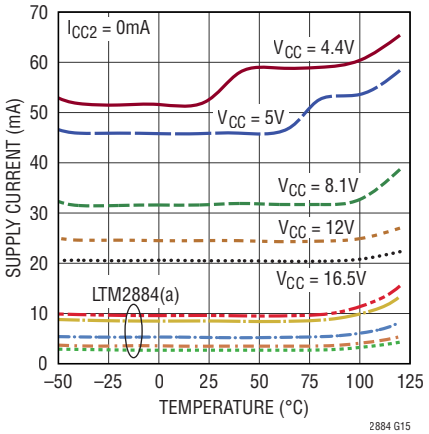
V_{CC2} = Load Step Response, 0mA to 500mA (V_{CC} = 12V)



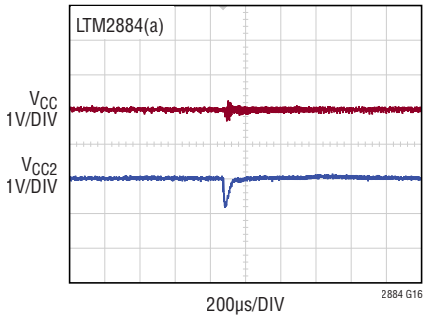
V_{CC2} = Load Step Response, 0mA to 200mA (V_{CC} = 5V)



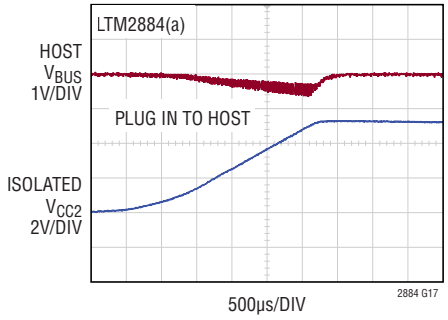
I_{CC} vs Temperature



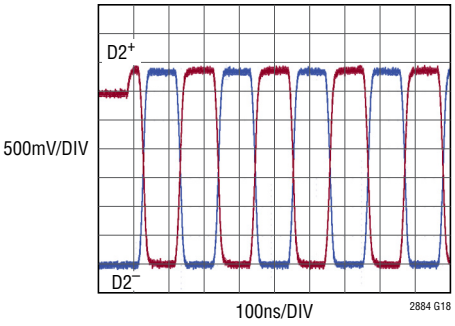
V_{CC2} Droop/Plug-In Response



Upstream V_{BUS} Droop During Plug-In with C_{LOAD} = 100µF



Full Speed Data Start of Packet



PIN FUNCTIONS

Upstream Side (V_{CC}, V_{BUS}, V_{LO}, GND)

$D1^-$ (A1): USB Data Bus Upstream Facing Negative Transceiver Pin. A 1.5k pull-up resistor is automatically configured to indicate the idle condition of the $D2^-$ pin.

$D1^+$ (A2): USB Data Bus Upstream Facing Positive Transceiver Pin. A 1.5k pull-up resistor is automatically configured to indicate the idle condition of the $D2^+$ pin.

SPNDPWR (A3): Suspend Power Control. A high input enables the DC/DC converter shutdown control if the USB bus is suspended. A low input (GND) disables the shutdown control to the DC/DC converter maintaining power to the isolated downstream side during suspend mode. The recovery time from suspend mode may be equivalent to the power supply start-up time if the DC/DC converter was shut down. The SPNDPWR pin is referenced to V_{LO} and GND.

ON (A4): Enable for Power and Data Communication Through the Isolation Barrier. If ON is high, the part is enabled. If ON is low, the upstream side is held in reset and the isolated side is unpowered by the DC/DC converter. The ON pin is referenced between V_{LO} and GND.

V_{LO} (A5): Internally Regulated 3.3V Logic Voltage Output. The V_{LO} pin is used as a positive reference for the ON and SPNDPWR pins and can source up to 10mA of surplus current. Internally bypassed to GND with 2.2µF. Output supply, no external connection necessary.

GND (A6, B1-B11): Upstream Circuit Ground.

V_{BUS} (A7): Voltage Supply Input to USB Transceiver. The operating range is 4.4V to 16.5V. Connect to the USB V_{BUS} supply or an external source. Internally bypassed to GND with 2.2µF.

V_{CC} (A8-A11): Voltage Supply Input to DC/DC Converter. The operating range is 4.4V to 16.5V. Connect to an external supply greater than 8.6V for 500mA on V_{CC2},V_{BUS} must be connected to the external supply or USB power. Connect to the USB V_{BUS} for up to 200mA on V_{CC2}. Connect V_{CC} to V_{BUS} when the peripheral device has an external power source. Internally bypassed to GND with 4.7µF.

Isolated Downstream Side (V_{CC2}, V_{LO2}, GND2)

GND2 (K1-K11, L3, L4, L6, L7): Downstream Circuit Ground.

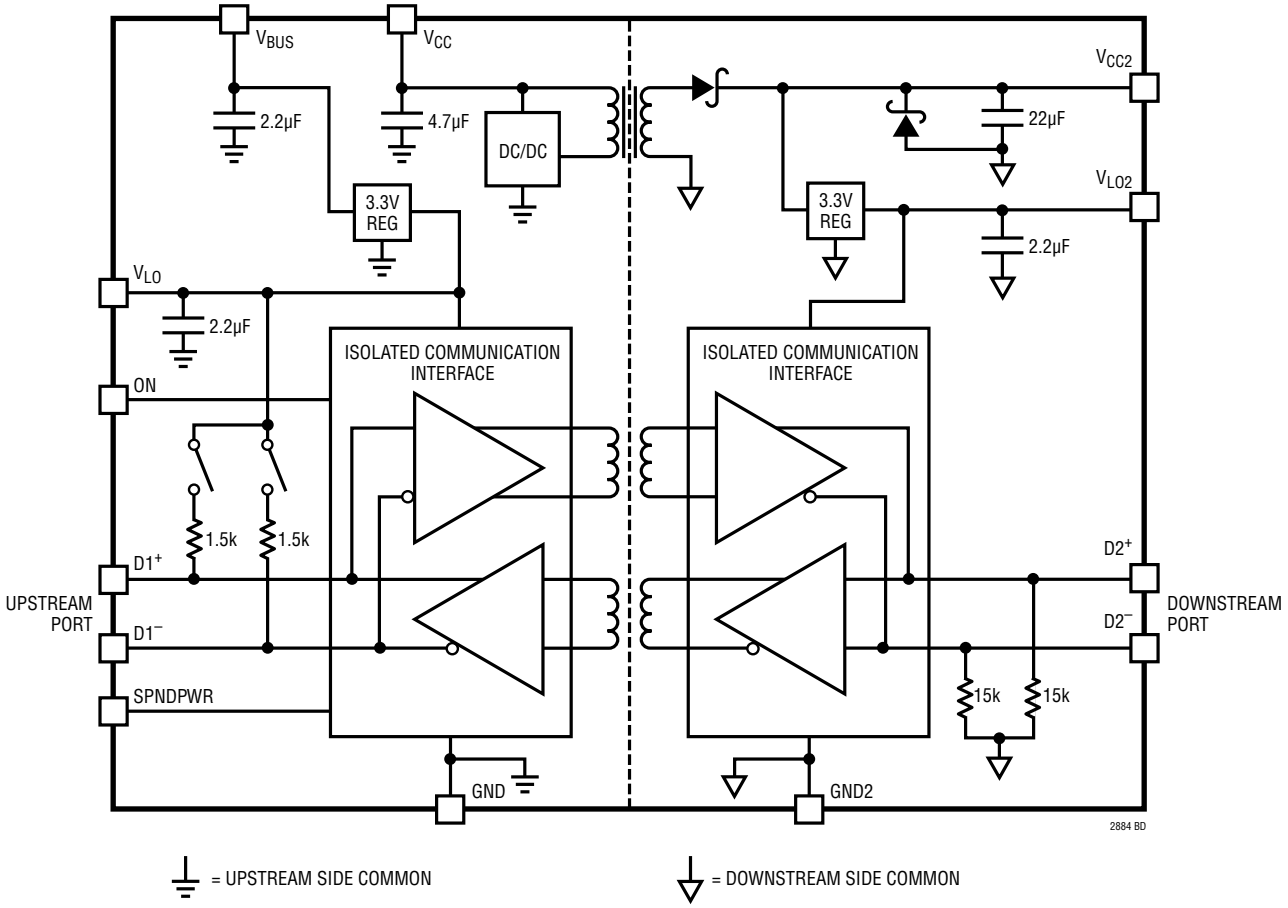
$D2^-$ (L1): USB Data Bus Downstream Facing Negative Transceiver Pin. The pin has a 15k pull-down resistor to GND2.

$D2^+$ (L2): USB Data Bus Downstream Facing Positive Transceiver Pin. The pin has a 15k pull-down resistor to GND2.

V_{LO2} (L5): Internally Regulated 3.3V Logic Voltage Output. The V_{LO2} pin can source up to 10mA of surplus current. Internally bypassed to GND2 with 2.2µF. Output supply, no external connection necessary.

V_{CC2} (L8-L11): Isolated Voltage Supply Output from DC/DC Converter. Output voltage is 5V and can support up to 500mA of peripheral device current referenced to GND2. Output current is dependant on input supply voltage and current limit. Internally bypassed to GND2 with 22µF. Output supply, no external connection necessary.

BLOCK DIAGRAM



TEST CIRCUITS

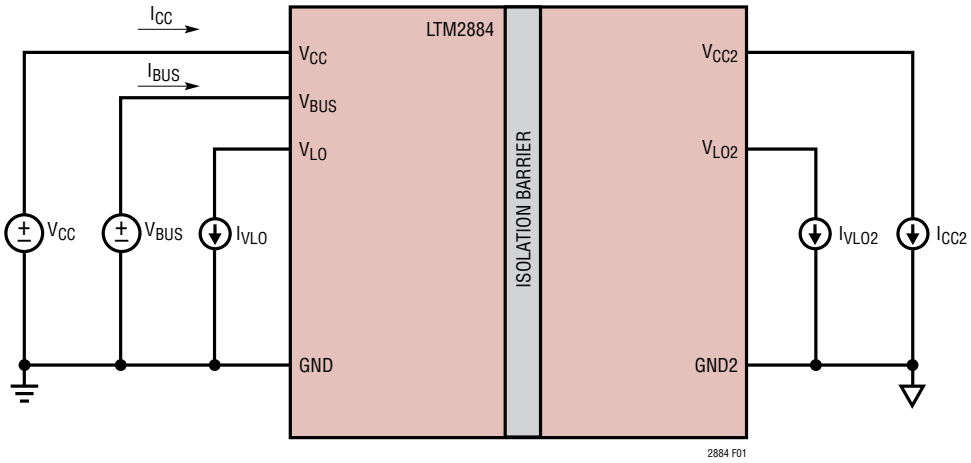


Figure 1. Power Supply Loads

TEST CIRCUITS

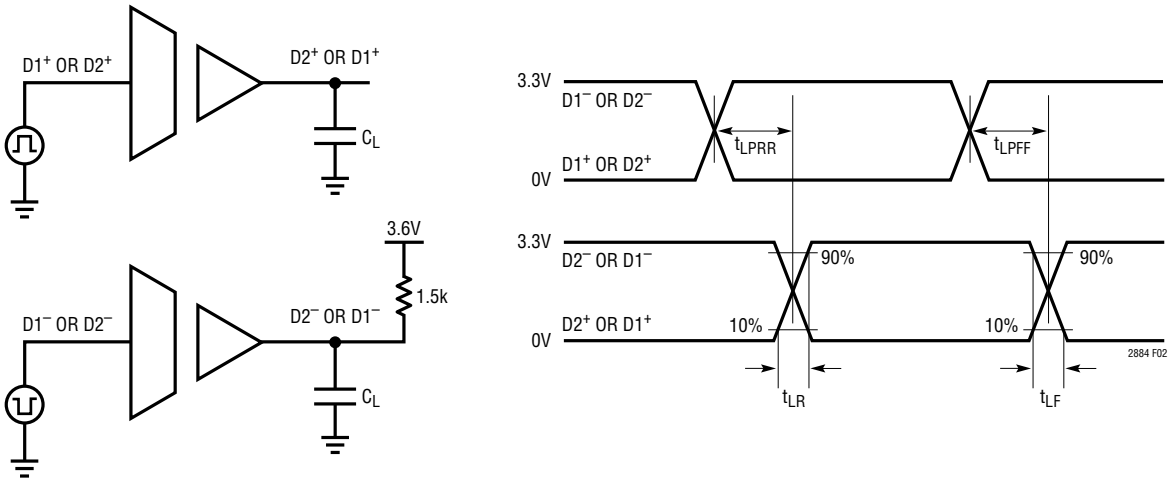


Figure 2. Low Speed Timing Measurements

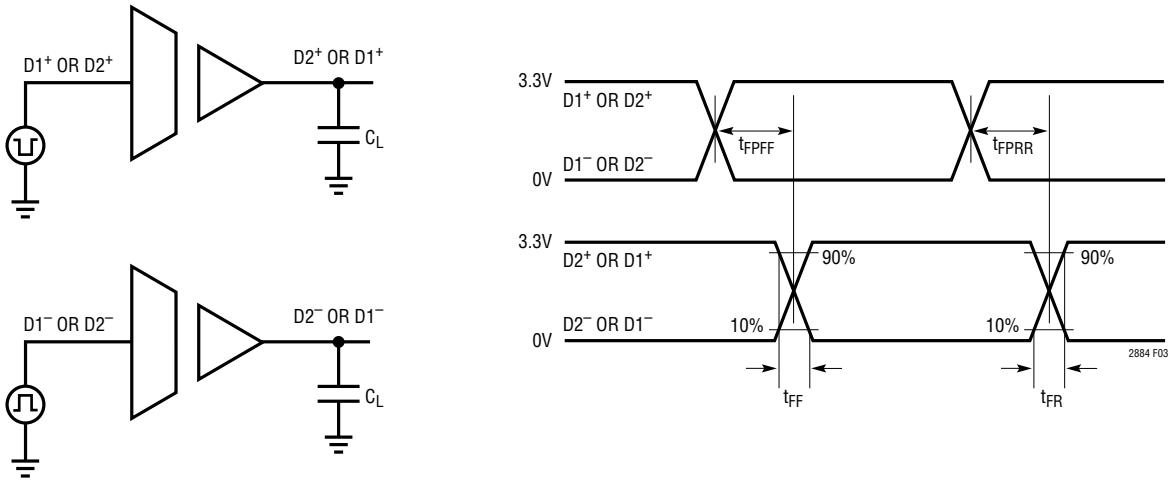


Figure 3. Full Speed Timing Measurements

FUNCTIONAL TABLE

USB Transceiver Functional Table

MODE	$D1^+$	$D1^-$	AUTOMATIC PULL-UP CONNECTION	$D2^+$	$D2^-$	SPNDPWR
Full Speed (Idle)	1.5k Pull-Up	Host Pull-Down	$D1^+$	Peripheral Pull-Up	15k Pull-Down	X
Low Speed (Idle)	Host Pull-Down	1.5k Pull-Up	$D1^-$	15k Pull-Down	Peripheral Pull-Up	X
Disconnected (Idle)	Host Pull-Down	Host Pull-Down	None	15k Pull-Down	15k Pull-Down	X
Suspend (Idle >3ms)	Set at Device Connect	Set at Device Connect	Set at Device Connect	Peripheral or 15k	Peripheral or 15k	0
Suspend No Power (Idle >3ms)	Set at Device Connect	Set at Device Connect	Set at Device Connect	15k Pull-Down	15k Pull-Down	3.3V
D1 to D2 Data	IN^+	IN^-	Set at Device Connect	OUT^+	OUT^-	X
D2 to D1 Data	OUT^+	OUT^-	Set at Device Connect	IN^+	IN^-	X

Power Functional Table

MODE	ON	SPNDPWR	V_{CC}	V_{BUS}	DC/DC CONVERTER
Off	0	X	X	X	OFF
On	3.3V	X	>4.4V	>4.4V	ON
On, Suspend (Idle >3ms)	3.3V	0	>4.4V	>4.4V	ON
On, Suspend (Idle >3ms), Power Off	3.3V	3.3V	>4.4V	>4.4V	OFF
On, USB Transceiver Only Power Off	3.3V	X	0	>4.4V	OFF

OPERATION

The LTM2884 µModule transceiver provides a galvanically isolated robust USB interface, powered by an integrated, regulated DC/DC converter, complete with decoupling capacitors. This flexible device can support a variety of USB configurations, either bus powered or externally powered. Applications include isolation in hosts, hubs, peripherals, or standalone inline bus splitters. Automatically configured pull-up resistors are included to represent the condition of the isolated downstream USB bus to the upstream USB bus. The LTM2884 is ideal for use in USB connections where grounds between upstream hub/host and downstream devices can take on different voltages. Isolation in the LTM2884 blocks high voltage differences and eliminates ground loops and is extremely tolerant of common mode transients between ground potentials. Error free operation is maintained through common mode events exceeding 30kV/µs providing excellent noise isolation.

The LTM2884 contains a fully integrated DC/DC converter including the transformer, so that no external components are necessary in many configurations. The upstream side contains a flyback converter that regulates the downstream output voltage through primary sensing techniques. The internal power solution is sufficient to support the transceiver interface and supply up to 500mA at 5V through V_{CC2} to an attached device dependent on the supply voltage and available current on V_{CC}.

The integrated USB transceivers on both sides of the isolation barrier support full and low speed modes defined in the USB 2.0 specification. The communication through the isolation barrier for USB is bidirectional and as such the LTM2884 determines data flow direction based on which side a start of packet (SOP) begins first. The direction of data is maintained until an end of packet (EOP) pattern is observed or a timeout occurs due to a lack of activity. The USB interface maintains a consistent propagation delay representative of a hub delay and transfers all data.

Pull-up resistors integrated in the upstream interface automatically indicate device connections and disconnections. A downstream device connection automatically selects the proper pull-up resistor at the upstream facing port after sensing the idle state of the downstream device at connection time. Disconnection of a downstream device automatically releases the pull-up resistor on the upstream facing port allowing the upstream 15k pull-down resistors to pull the bus signals to a disconnect condition. This function makes the LTM2884 ideal for host, hub, bus splitter, or peripheral device integration.

Isolator µModule Technology

The LTM2884 utilizes isolator µModule technology to translate signals and power across an isolation barrier. Signals on either side of the barrier are encoded into pulses and translated across the isolation boundary using differential signaling through coreless transformers formed in the µModule substrate. This system, complete with data refresh, error checking, safe shutdown on fail, and extremely high common mode immunity, provides a robust solution for bidirectional signal isolation. The µModule technology provides the means to combine the isolated signaling with a USB transceiver and powerful isolated DC/DC converter in one small package.

USB Transceiver Pin Protection

The LTM2884 USB transceiver pins $D1^+$, $D1^-$, $D2^+$, and $D2^-$ have protection from ESD and short-circuit faults. The transceiver pins withstand ±15KV HBM ESD events. Overcurrent circuitry on the transceiver pins monitor fault conditions from $D1^+$ and $D1^-$ to GND, V_{LO}, or V_{BUS} and from $D2^+$ and $D2^-$ to GND2, V_{LO2}, or V_{CC2}. A current detection circuit disables the transceiver pin if the pin sinks about 40mA for greater than 600ns. The V_{LO} and V_{LO2} output supplies protect the USB transceiver pins from shorts to GND or GND2 respectively with a 40mA current limit.

APPLICATIONS INFORMATION

USB Connectivity

The LTM2884 µModule transceiver connects directly to USB ports on the upstream side and the downstream side without the addition of external components. The transceiver passes through all data and does not act as a hub or intelligent device. The bus lines are monitored for idle conditions, start of packet, and end of packet conditions to properly maintain bus speed and data direction. The series resistance, pull-up, and pull-down resistors are built into the LTM2884. The upstream facing USB port contains automatically configured 1.5k pull-up resistors which are switched in or out based on the downstream side peripheral device configuration. This implementation allows upstream reporting of the downstream bus speed and connection/disconnection conditions. Built-in 15k pull-down resistors are included from the $D2^+$ and $D2^-$ signals to GND2 supporting the downstream bus configuration.

Monitoring the USB data pins, the LTM2884 detects a K-state to begin a data packet and set the data direction. The data is monitored for an end of packet signature and a finishing J-state before the bus is released. The data payload between the K-state and J-state is transferred through the LTM2884 isolator with a delay of approximately 80ns.

Idle State Communication and Automatic Speed Selection

The LTM2884 µModule transceiver maintains the conditions of the USB bus idle state by monitoring the downstream side bus idle condition and refreshing the state across the isolation barrier at a consistent rate. Furthermore, the LTM2884 monitors the speed of the downstream peripheral once connected and sets its own operation to match. Figure 4 shows the abbreviated circuitry of the automatic monitoring and reporting of the bus speeds. The $D2^+$ or $D2^-$ signals are monitored for a connection to pull-ups on $D2^+$ or $D2^-$ and the result is processed as full speed or low speed, otherwise disconnect. The idle state is communicated to the upstream side through a refresh transmission. The switches SW1 or SW2 are controlled based on the received information. SW1 is closed if $D2^+$ is detected to have a pull-up and $D2^-$ was open. SW2 is closed if $D2^-$ is detected to have a pull-up and $D2^+$ was open. Both SW1 and SW2 are opened if the downstream USB bus is disconnected.

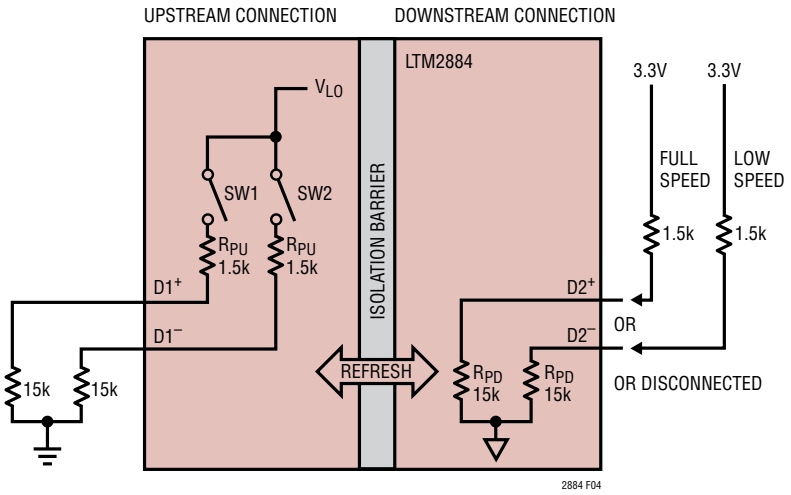


Figure 4. Idle State Automatic Resistor Setting

APPLICATIONS INFORMATION

During a USB suspend, the pull-up resistor will maintain the condition prior to detecting the suspend command.

Suspend Mode

When the upstream USB bus is idle for greater than 3ms, the LTM2884 enters suspend mode. The power savings and behavior in suspend mode depend on the state of the SPNDPWR pin, as summarized in Table 1.

Table 1. Suspend Mode Operation

SPNDPWR	V_{CC2}	I_{BUS}	I_{CC}	WAKE-UP	WAKE-UP TIME
High	Off	< 500µA	V_{CC}/45k	Resume	3ms
Low	On	1.5mA	50mA	Resume or Remote Wake-Up	10µs

The biggest power savings in suspend mode comes when SPNDPWR is high. In this case, the DC/DC converter is disabled, shutting down power to the isolated side, while the current draw on V_{CC} and V_{BUS} are minimized. However, in this mode, if a downstream device is connected or disconnected from the bus or remote wake-up functionality is configured, it will not be recognized by the LTM2884 and will not be relayed to the host. A resume command at the upstream side will wake up the LTM2884 and a re-numeration by the host will be required. Recovery time is about 3ms from the start of the resume command on the upstream side.

If SPNDPWR is low in suspend mode, the LTM2884 operates in a low power mode but maintains a higher functional state with the DC/DC converter on and the downstream transceiver powered. The V_{BUS} current is reduced to 1.5mA and V_{CC} current is about 50mA when there is no external draw on V_{CC2}. Wake-up is initiated with disconnects, reconnects, or a remote wake-up command from a downstream device or a resume command from the host. Recovery time from suspend mode is about 10µs from when the first state change is detected.

During suspend mode DC current drawn from V_{LO} into external circuits will be supplied from V_{BUS} and may exceed the limits set in the USB specification.

DC/DC Power Supply

The internal DC/DC converter converts the input power from the V_{CC} pin to the V_{CC2} output. The power delivered to the V_{CC2} pin is regulated and current limited to protect against overcurrent conditions. The voltage supply, V_{CC}, is sensed to limit the maximum current that can be delivered before USB specifications are exceeded. Connecting the V_{CC} and V_{BUS} supply pins to the USB V_{BUS} pin (4.4V to 5.5V) limits the maximum downstream side supply current to 200mA before V_{CC2} supply degradation. When V_{CC} is connected to a high voltage external DC source (8.6V to 16.5V) the current limit is increased so that 500mA is sourced from V_{CC2}. If a downstream device sinking current from V_{CC2} draws more than 25mA, the input current on V_{CC} may exceed 100mA, the USB single unit load specification for low power devices. The LTM2884 does not enforce a 100mA current limit for low power peripherals.

V_{CC2} is internally decoupled to GND2 with a 22µF capacitor. Add an additional low ESR 100µF capacitor to V_{CC2} to meet the V_{BUS} downstream supply decoupling minimum specification of 120µF when supporting device plug in. Locate the additional 100µF capacitor adjacent to the downstream USB connector. Additional capacitance may not be necessary when the LTM2884 is used in a peripheral device, or upstream hub application.

V_{LO} and V_{LO2} Supplies

The V_{LO} and V_{LO2} output supply pins are available for use as low current 3.3V supplies on both sides of the isolation barrier. They also serve as supplies for the USB interface circuitry. An internal linear regulator maintains 3.3V on V_{LO} from the V_{BUS} input supply. A separate linear regulator maintains 3.3V on V_{LO2} from V_{CC2}. The current is limited to 10mA for external applications. Exceeding this limit may cause degradation in the V_{LO} or V_{LO2} supplies and undesirable operation from the USB isolator. Connection of signals ON or SPNDPWR to V_{LO} will not cause a significant change in the available V_{LO} current.

APPLICATIONS INFORMATION

These supplies are available to support interface logic to the isolated USB port. In order to meet the suspend mode current limit, minimize the DC current of external applications on the V_{LO} output supply. V_{LO} and V_{LO2} are protected from overcurrent and overtemperature conditions.

Supply Current

Loading the multiple output supply pins of the LTM2884 affects the supply current on V_{BUS} and V_{CC}. The V_{BUS} input supplies current to the the upstream side of the transceiver and to the V_{LO} pin. The V_{CC} input supplies power to V_{CC2} and V_{LO2} through an isolated DC/DC converter. The efficiency (η) of the DC/DC converter is shown in the Typical Performance Characteristics section for 5V and 12V inputs from V_{CC} to V_{CC2}.

Supply Current Equations

Operating:

$$I_{BUS} = 6mA + I_{VLO}$$

$$I_{CC} = \frac{V_{CC2} \bullet \left(6mA + I_{CC2} + I_{VLO2}\right)}{\eta \bullet V_{CC}}$$

Suspend: SPNDPWR = 0

$$I_{BUS} = 1.5mA + I_{VLO}$$

$$I_{CC} = \frac{V_{CC2} \bullet \left(6mA + I_{CC2} + I_{VLO2}\right)}{\eta \bullet V_{CC}}$$

Suspend: SPNDPWR = V_{LO}

$$I_{BUS} = 0.45mA + I_{VLO}$$

$$I_{CC} = \frac{V_{CC}}{45k}$$

Off:

$$I_{BUS} = 10\mu A$$

$$I_{CC} = \frac{V_{CC}}{45k}$$

USB 2.0 Compatibility

The LTM2884 µModule transceiver is compatible with the USB 2.0 specification of full and low speed operation. Some characteristics and implementations may not support full compliance with the USB 2.0 specification. Three specific cases exist within the LTM2884 µModule transceiver and the integrated DC/DC power converter.

First, the propagation delay for full speed data of 80ns exceeds the specification for a single hub of 44ns plus the attached cable delay of 26ns. This is due to driving the signal to the 3.3V rail prior to a K-state transition to maintain balanced crossover voltages equivalent to the cross over voltages of the successive data transitions. USB ports commonly drive the idle state bus to the 3.3V rail prior to the k-state start of packet transition.

Second, setting SPNDPWR = V_{LO} will cause the DC/DC power converter to turn off during a bus suspend. V_{CC2} will lose power causing the downstream device to lose enumeration. Remote wake-up, disconnect, and reconnect events are ignored. A resume command from the host or upstream hub will start the DC/DC converter and wake up the downstream device. The downstream device will require re-enumeration, which causes a failure in USB compliance testing. After a resume command initiates, a delay of 3ms will elapse before the isolated device is fully powered. When SPNDPWR = 0V, the DC/DC power converter remains on during suspend, therefore power and enumeration information is retained. The V_{CC} supply consumes 50mA to support the isolated power during suspend. Separate the V_{BUS} and V_{CC} supplies to comply with the 2.5mA USB 2.0 V_{BUS} suspend current specification.

Third, when connecting a low power device to the downstream side of the LTM2884 and V_{BUS} and V_{CC} are connected together, the input current is higher due to the operating current and the efficiency of the DC/DC converter. The operating current of the DC/DC converter and the USB transceiver function is 46mA. The efficiency of the converter is approximately 55%, resulting in a 1/0.55 increase in the input current due to the load current on V_{CC2}. A 100mA load on V_{CC2} appears as a 181mA load + operating current at V_{BUS} and V_{CC}. In order to meet

APPLICATIONS INFORMATION

a 100mA input current, the V_{CC2} load current must be less than 25mA. This characteristic of an isolated supply may limit the use of the LTM2884 in bus powered hub applications or downstream connection to a bus powered hub. Connect V_{CC} to an external supply to mitigate this concern.

Hot Plug Protection

The V_{CC} and V_{BUS} inputs are bypassed with low ESR ceramic capacitors. During a hot plug event, the supply inputs can overshoot the supplied voltage due to cable inductance. When using external power supply sources greater than 10V that can be hot plugged, add an additional 2.2µF tantalum capacitor with greater than 1Ω of ESR, or a ceramic capacitor with a series 1Ω resistor to the V_{CC} input to reduce the possibility of exceeding absolute maximum ratings. Refer to Application Note 88, "Ceramic Capacitors Can Cause Overvoltage Transients," for a detailed discussion of this problem.

PC Board Layout

The high integration of the LTM2884 makes PCB layout simple. However, to optimize its electrical isolation characteristics, EMI, and thermal performance, some layout considerations are necessary. The PCB layout in Figure 5 is a recommended configuration for a low EMI USB application. The following considerations optimize the performance of the LTM2884:

- Under loaded conditions, V_{CC} and GND current exceed 700mA, V_{CC2} and GND2 current is up to 500mA. Use sufficient copper on the PCB to ensure resistive losses do not cause the supply voltage to drop below the minimum allowed level. The heavy copper traces will also help to reduce thermal stress and improve thermal conductivity.
- Input and output decoupling is not required on peripheral or hub inputs. Add additional low ESR capacitance to reduce noise induction on the power supply connections. Hub/bus splitter outputs require an additional 100µF of low ESR capacitance.
- Do not place copper between the inner columns of pads on the top or bottom of the PCB. This area must remain open to withstand the rated isolation voltage and maintain the creepage distance.

RF, Magnetic Field Immunity

The isolator µModule technology used within the LTM2884 has been independently evaluated, and successfully passed the RF and magnetic field immunity testing requirements per European Standard EN 55024, in accordance with the following test standards:

EN 61000-4-3	Radiated, Radio-Frequency, Electromagnetic Field Immunity
EN 61000-4-8	Power Frequency Magnetic Field Immunity
EN 61000-4-9	Pulsed Magnetic Field Immunity

Tests were performed using an unshielded test card designed per the data sheet PCB layout recommendations. Specific limits per test are detailed in Table 2.

Table 2. Test Frequency Field Strength

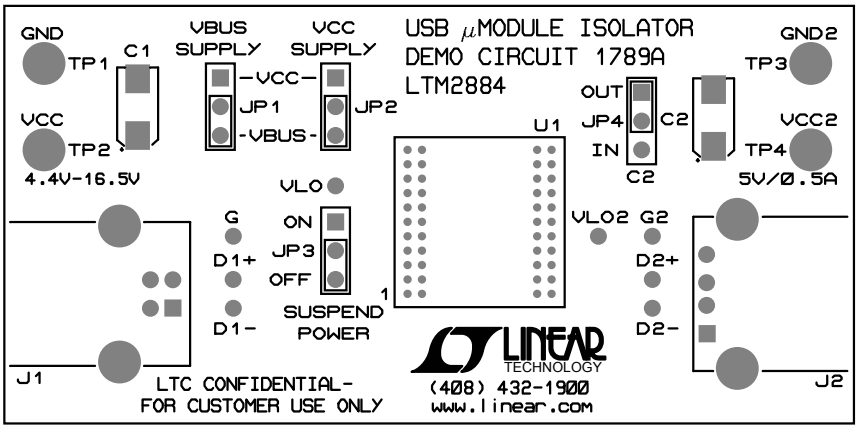
EN 61000-4-3, Annex D, 80MHz to 1GHz 1.4MHz to 2GHz 2GHz to 2.7GHz	10V/m 3V/m 1V/m
EN 61000-4-8, Level 4 50Hz and 60Hz	30A/m
EN 61000-4-8, Level 5 60Hz	100A/m*
EN 61000-4-9, Level 5 Pulse	1000A/m

*Non IEC Method

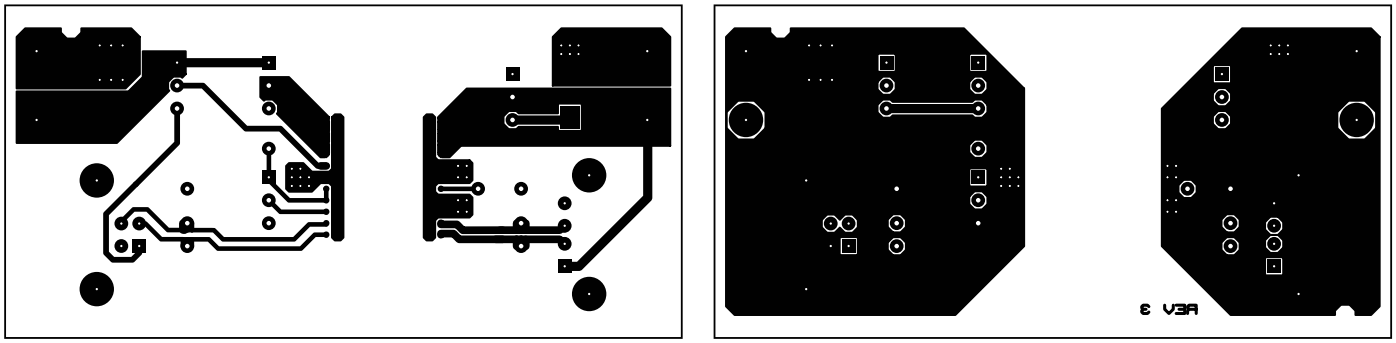
EMI

Radiated emissions have been measured for the LTM2884 using a gigahertz transverse electromagnetic (GTEM) cell with and without a USB cable attached. The performance shown in Figure 6 was achieved with the layout structure in Figure 5. Results are corrected per IEC 61000-4-20.

APPLICATIONS INFORMATION



DC1789a Demo Board



DC1789a Top

DC1789a Bottom

2884 F04

Figure 5. PC Board Layout

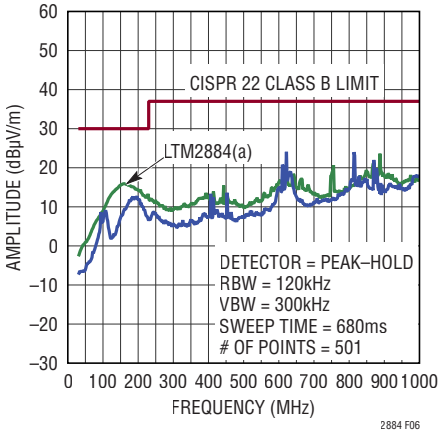


Figure 6. EMI Plot

TYPICAL APPLICATIONS

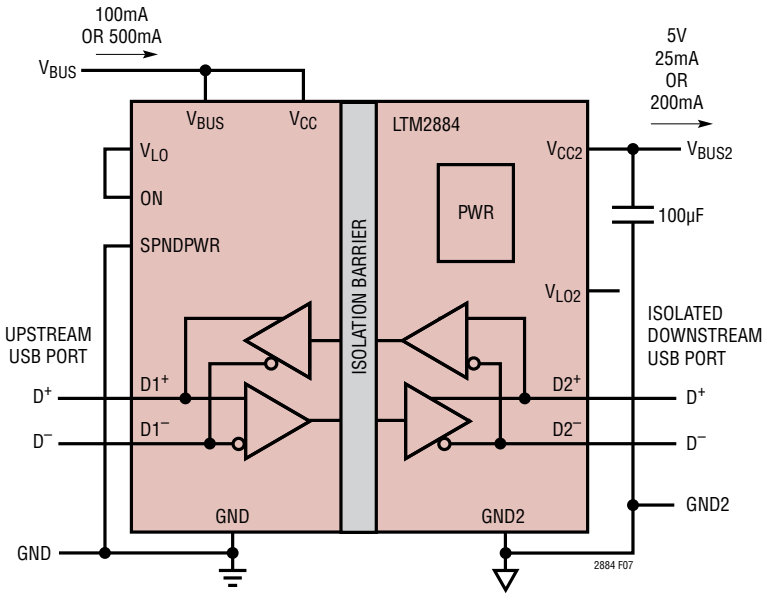


Figure 7. Bus Powered Inline Bus Splitter

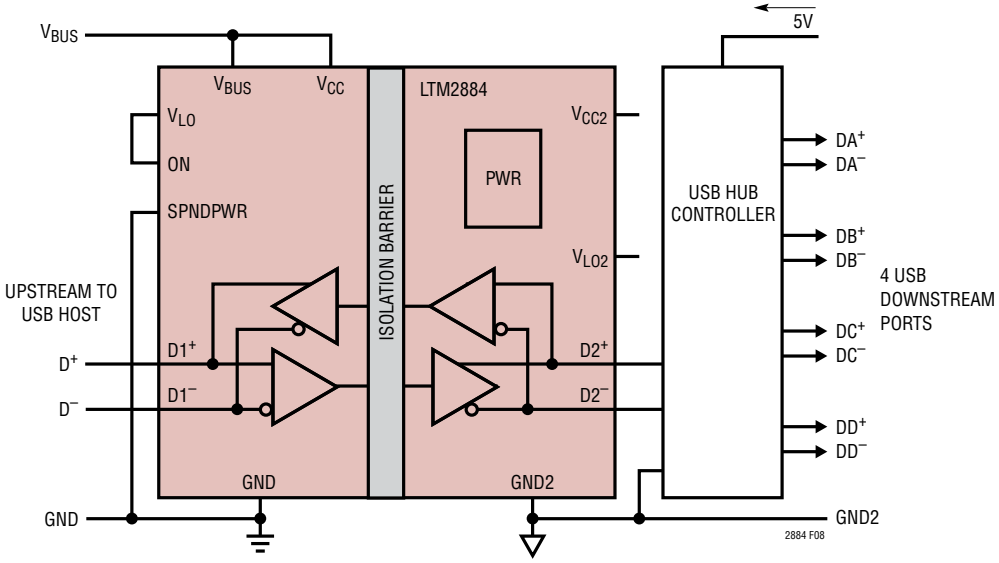


Figure 8. USB Hub Upstream Isolator

TYPICAL APPLICATIONS

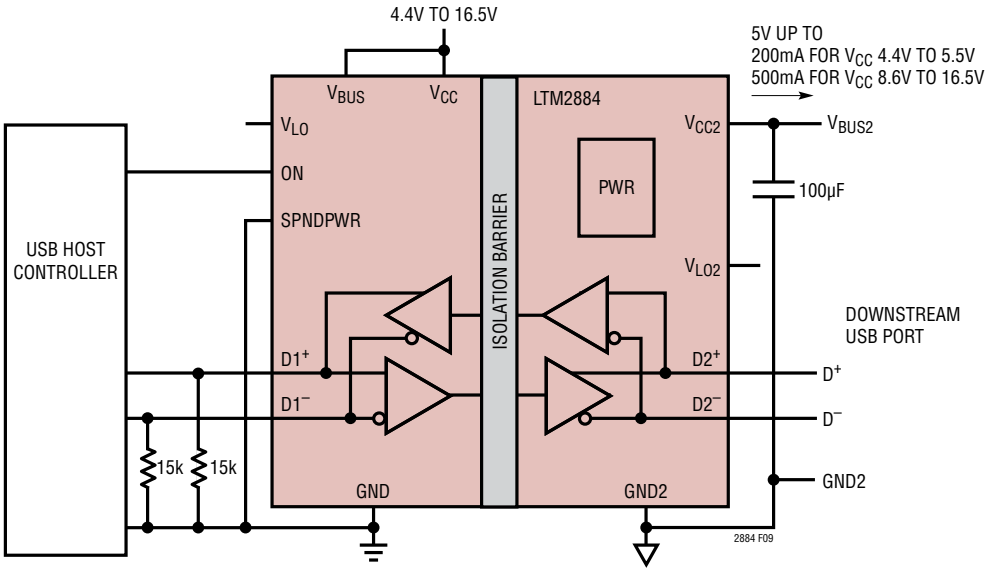


Figure 9. USB Host Integration

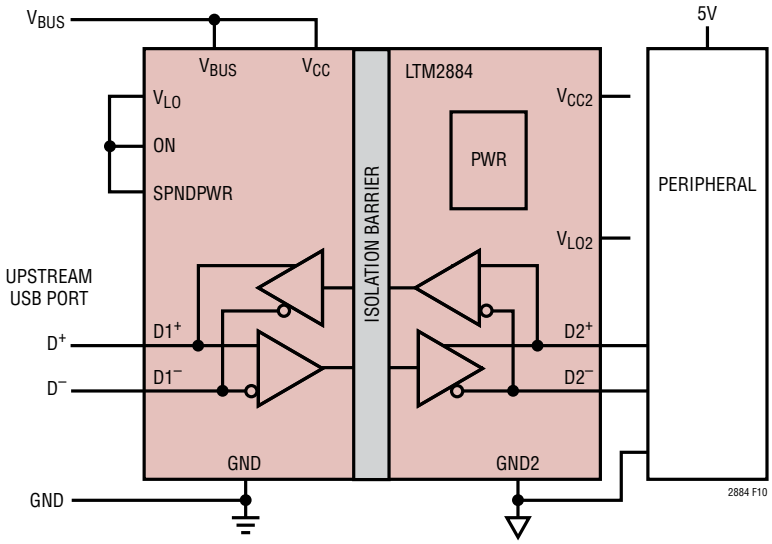


Figure 10. Powered Peripheral Device with USB Isolation and Low Current Suspend

TYPICAL APPLICATIONS

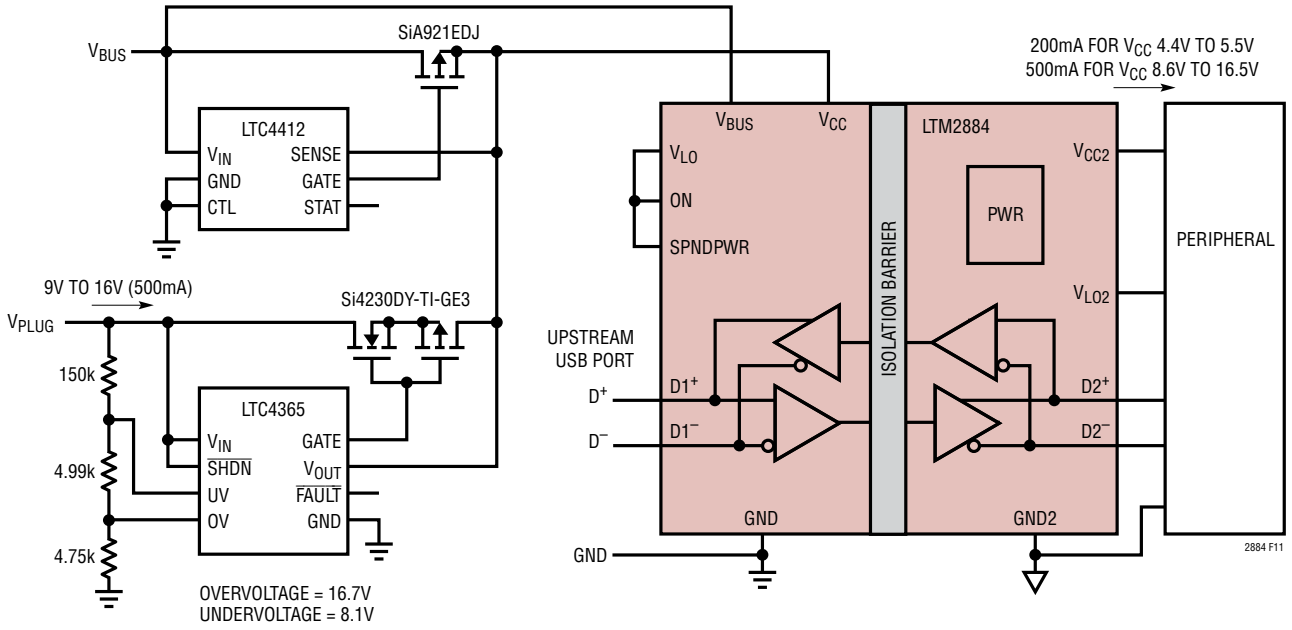


Figure 11. Bus or Self Powered USB Isolation with Low Current Suspend and Power Plug Detection

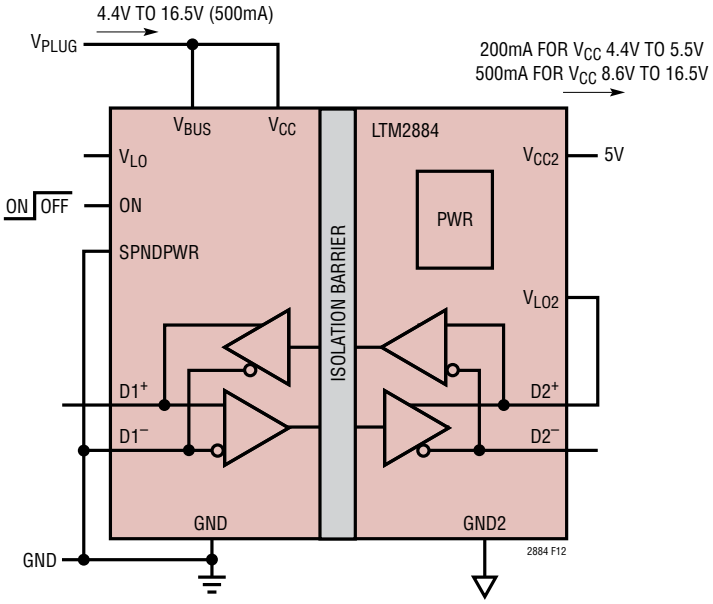
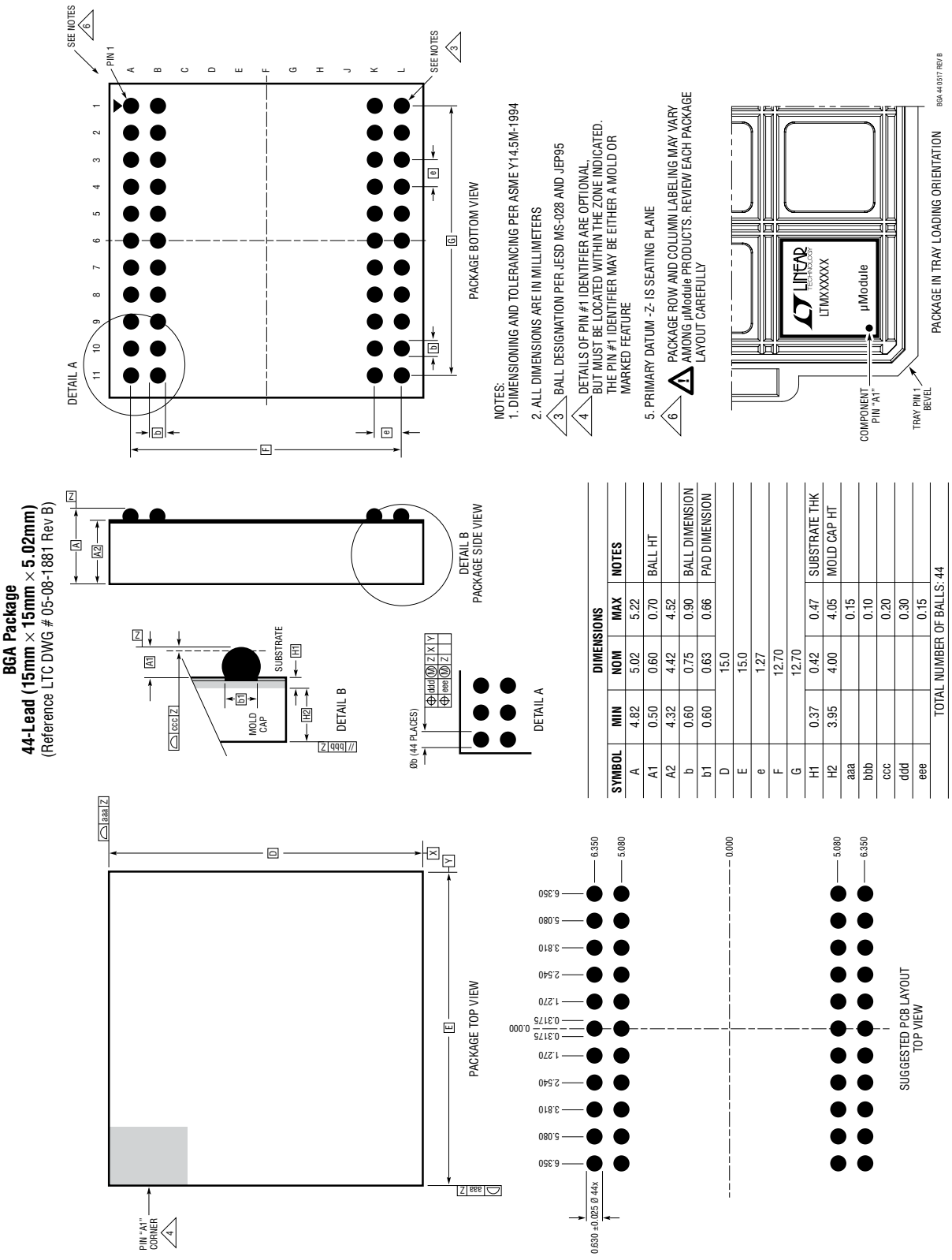


Figure 12. Isolated 1W or 2.5W Power Supply

PACKAGE DESCRIPTION



DIMENSIONS				
SYMBOL	MIN	NOM	MAX	NOTES
A	4.82	5.02	5.22	
A1	0.50	0.60	0.70	BALL HT
A2	4.32	4.42	4.52	
b	0.60	0.75	0.90	BALL DIMENSION
b1	0.60	0.63	0.66	PAD DIMENSION
D		15.0		
E		15.0		
e		1.27		
F		12.70		
G		12.70		
H1	0.37	0.42	0.47	SUBSTRATE THK
H2	3.95	4.00	4.05	MOLD CAP HT
aaa			0.15	
bbb			0.10	
ccc			0.20	
ddd			0.30	
eee			0.15	
TOTAL NUMBER OF BALLS: 44				

REVISION HISTORY

REV	DATE	DESCRIPTION	PAGE NUMBER
A	08/16	Added UL-CSA logo in Features list	1
B	11/16	Lowered Storage Temperature to –55°C	2
C	02/20	Added regulatory information and revised LTM2884(a) electrical parameters and curves	1–7, 18

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices.

TYPICAL APPLICATION

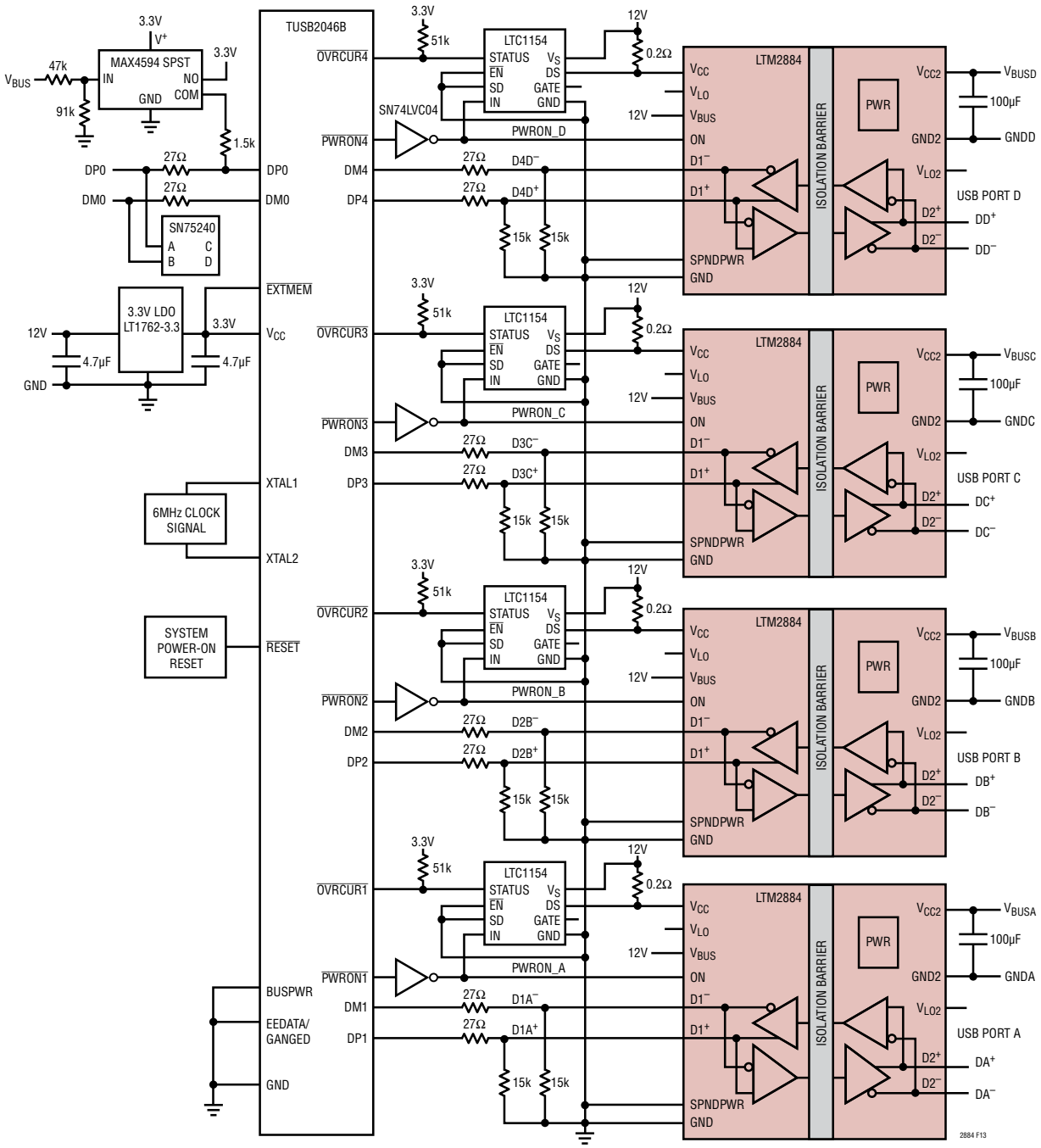


Figure 13. Self Powered 4-Port Hub with Independent Isolation

RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LTM2881	Complete Isolated RS485/RS422 µModule Transceiver + Power	2500V_{RMS} Isolation in Surface Mount BGA or LGA
LTM2882	Dual Isolated RS232 µModule Transceiver with Integrated DC/DC Converter	2500V_{RMS} Isolation in Surface Mount BGA or LGA
LTM2883	SPI or I^2C µModule Isolator with Adjustable ±12.5V and 5V Regulated Power	2500V_{RMS} Isolation in Surface Mount BGA
LTM2892	SPI/Digital or I^2C µModule Isolator	3500V_{RMS} Isolation, 6 Channels
LTM2894	USB µModule Isolator	7500V_{RMS} Isolation

© ANALOG DEVICES, INC. 2014-2020